

TS-XFP-CWDM-80

10Gbps CWDM XFP Optical Transceiver, 80km Reach

Features

- Supports 9.95Gb/s to 11.1Gb/s Bit Rates
- · Hot-pluggable XFP Footprint
- · Compliant with XFP MSA
- 8-Wavelengths CWDM EML Transmitter from 1470nm to 1610nm, with Step 20nm
- · Very Low TEC Power Consumption
- · Duplex LC Connector
- Power Dissipation <3.5W
- Operating Case Temperature Standard: 0°C to +70°C
- 2-Wire Interface for Integrated Digital Diagnostic Monitoring



Applications

- OC-192, STM-64
- 10GBASE-ZR/ZW 10G Ethernet
- 1200-SM-LL-L 10G Fiber Channel
- 10GE over G.709 at 11.09Gbps
- OC192 over FEC at 10.709Gbps

Description

The TS-XFP-CW DM-80 series optical transceiver is designed for fiber communications application such as SONET OC-192, STM-64, 10G Ethernet (10GBASE-ZR/ZW) and 10G Fiber Channel (1200-SM-LL-L), which fully compliant with the specification of XFP MSA Rev 4.5.

This module is designed for single mode fiber and operates at a nominal wavelength of CWDM wavelength. There are eight center wavelengths available from 1470nm to 1610nm, with each step 20nm.

The module is with the XFP 30-pin connector to allow hot plug capability. Only single 3.3V power supply is needed. The optical output can be disabled by LVTTL logic high-level input of TX_DIS. Loss of signal (RX LOS) output is provided to indicate the loss of an input optical signal of receiver.

This module provides digital diagnostic functions via a 2-wire serial interface as defined by the XFP MSA Rev 4.5.

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Absolute Maximum Ratings*Note

Parameter	Symbol	Min	Max	Unit
Maximum Supply Voltage	Vcc	-0.5	4.0	V
Operating Relative Humidity	RH		80	%
Storage Temperature	Ts	-40	+85	°C

Note: Exceeding any one of these values may destroy the device permanently.

Recommended Operating Conditions

Parameter	Symbol	Min	Typical	Max	Unit
Operating Case Temperature	Tc	0		+70	°C
Pow er Supply Voltage @ 3.3V	Vcc3	3.13	3.3	3.45	V
Pow er Supply Voltage @ 5V	Vcc5	4.75	5	5.25	V
Supply Current-Vcc3 supply	lcc3			300	mA
Supply Current-Vcc5 supply	lcc5			750	mA
Module Total Power	Р			3.5	W

Electrical Characteristics

Parameter	Symbol	Min	Typical	Max	Unit	Notes
		Transmitte	er			
Input Differential Impedance	Rin		100		Ω	1
Differential Data Input Swing	Vin,pp	180		820	mV	
Transmit Disable Voltage	V _D	2.0		Vcc	V	
Transmit Enable Voltage	V _{EN}	GND		GND+ 0.8	V	
Transmit Disable Assert Time				10	us	
	·	Receive				
Differential Data Output Swing	Vout,pp	340	650	850	mV	1
Rise Time (20-80%)	tr			38	ps	
Fall Time (20- 80%)	tf			38	ps	
LOS Fault	V _{LOS} fault	Vcc -0.5		VccHOST	V	2
LOS Normal	V _{LOS norm}	GND		GND+0.5	V	2

Note1: After internal AC coupling

Note2: Loss of signal is open collector. Logic 0 indicates normal operation; logic 1 indicates no signal detected.



Optical Characteristics

Parameter	Symbol	Min	Typical	Max	Unit	Note
	Transmitte	er	-			
Centre Wavelength	λς	λс-6	λc	λc+7.5	nm	1
Spectral Width (-20dB)	Δλ			1	nm	
Side Mode Suppression Ratio	SMSR	32			dB	
Average Output Power	Pout	0		5	dBm	
Extinction Ratio	ER	8.2			dB	
Average Launch Power of OFF Transmitter	Poff			-30	dBm	
TX Jitter	T _{Xj}	Per 802.3ae requirements				
Relative Intensity Noise	RIN			-135	dB/Hz	
	Receive	r				
Centre Wavelength	λς	1260		1620	nm	
Receiver Sensitivity	P _{min}			-24	dBm	2
Receiver Overload	P _{MAX}	-10			dBm	
Receiver Reflectance	Rf			-12	dB	
LOS De-Assert	LOS _D			-25	dBm	
LOS Assert	LOSA	-37			dBm	
LOS Hysteresis		1			dB	

Note1: Π U-T G.694.2 CWDM wavelength from 1470nm to 1610nm, each step 20nm. Note2: Average received power; BER less than 1E-12 and PRBS 2^{31} -1 test pattern.

CWDM Wavelength (0°C ~70°C)

Band	Nomenclature	Wavelength(nm)				
	Nomendatare	Min	Тур	Max		
S-band Short Wavelength	47	1464	1470	1477.5		
	49	1484	1490	1497.5		
	51	1504	1510	1517.5		
	53	1524	1530	1537.5		
C-band Conventional	55	1544	1550	1557.5		
L-band Long Wavelength	57	1564	1570	1577.5		
	59	1584	1590	1597.5		
	61	1604	1610	1617.5		

Note: 8 Wavelengths from 1470nm to 1610nm, each step 20nm.



Pin Descriptions

Pin	Logic	Symbol	Name/Description	Note
1		GND	Module Ground	1
2		VEE5	Optional -5.2V Pow er Supply (Not required)	
3	LVTTL-I	MOD_DESEL	Module De-select; When held low allows the module to respond to 2-wire serial interface	
4	LVTTL-O	INTb	Interrupt; Indicates presence of an important condition which can be read via the 2-wire serial interface	2
5	LVTTL-I	TX_DIS	Transmitter Disable; Turns off transmitter laser output	
6		VCC5	+5V Pow er Supply	
7		GND	Module Ground	1
8		VCC3	+3.3V Pow er Supply	
9		VCC3	+3.3V Pow er Supply	
10	LVTTL-I/O	SCL	2-Wire Serial Interface Clock	2
11	LVTTL-I/O	SDA	2-Wire Serial Interface Data Line	2
12	LVTTL-O	MOD_Abs	Indicates Module is not present. Grounded in the Module	2
13	LVTTL-O	MOD_NR	Module Not Ready; Indicating Module Operational Fault	2
14	LVTTL-O	RX_LOS	Receiver Loss Of Signal Indicator	
15		GND	Module Ground	
16		GND	Module Ground	1
17	CML-O	RDN	Receiver Inverted Data Output	
18	CML-O	RDP	Receiver Non-Inverted Data Output	
19		GND	Module Ground	1
20		VCC2	+1.8V Pow er Supply (Not required).	3
21	LVTTL-I	P_DOWN/RST	Pow er down; When high, requires the module to limit pow er consumption to 1.5W or below. 2-Wire serial interface must be functional in the low power mode. Reset; The falling edge initiates a complete reset of the module including	
22		VCC2	the2-w ire serial interface, equivalent to a pow er cycle.	
			+1.8V Pow er Supply (Not required)	3
23	PECL-I	GND REFCLKP	Module Ground	1
24			Not used, internally terminated to 50ohm (100ohm diff).	4
25	PECL-I	REFCLKN	Not used, internally terminated to 50ohm (100ohm diff).	4
26		GND	Module Ground	1
27	ON #L !	GND	Module Ground	1
28	CML-I	TDN	Transmitter Inverted Data Input	
29	CML-I	TDP	Transmitter Non-Inverted Data Input	
30		GND	Module Ground	1

Notes:

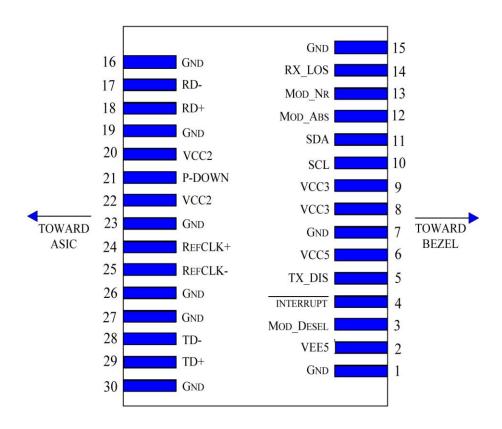
^{1.} Module ground pins GND are isolated from the module case and chassis ground within the module.

^{2.} Open collector; shall be pulled up with 4.7K-10Kohms to a voltage between 3.15V and 3.6V on the host board.



- 3. The pinsare open within module.
- 4. Reference Clockis not required.

Host board Connector Pin out



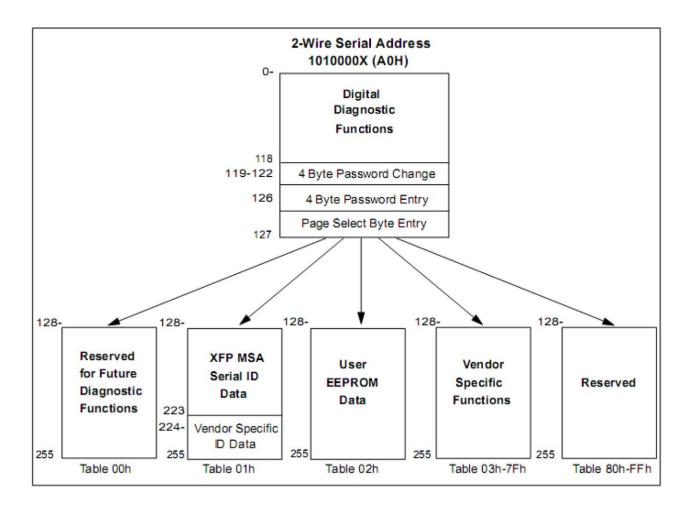


Management Interface

The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

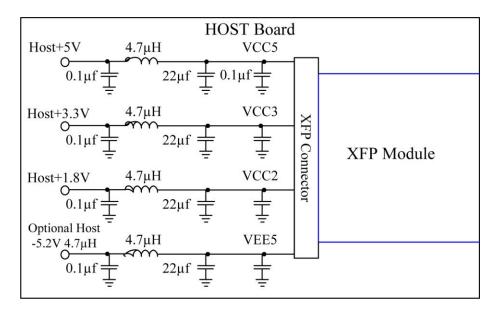
The Module provides diagnostic information about the present operating conditions. The transceiver generates this diagnostic data by digitization of internal analog signals. Alarm/warning threshold data is written during device manufacture. Received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring all are implemented.

The digital diagnostic memory map specific data field defines as following.

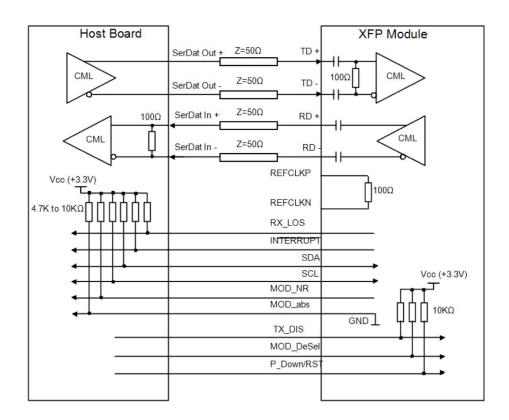




Recommended Host Board Power Supply Circuit

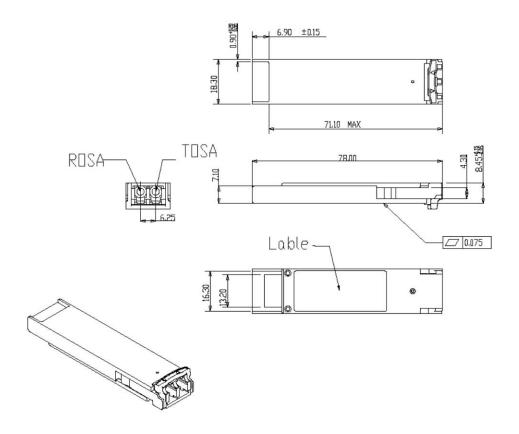


Recommended High-speed Interface Circuit





Package Dimensions



Eye Safety

This single-mode transceiver is a Class 1 laser product. It complies with IEC-60825 and FDA 21 CFR 1040.10 and 1040.11. The transceiver must be operated within the specified temperature and voltage limits. The optical ports of the module shall be terminated with an optical connector or with a dust plug.



Regulatory Compliance

Feature	Stand ard	Perform ance
Electrostatic Discharge (ESD) to the Electrical Pins	MIL-STD-883G Method 3015.7	Class 1C (>1000 V)
Electrostatic Discharge to the enclosure	EN 55024:1998+A1+A2 IEC-61000-4-2 GR-1089-CORE	Compliant with standards
Electromagnetic Interference (EMI)	FCC Part 15 Class B EN55022:2006 CISPR 22B:2006 VCCI Class B	Compliant with standards Noise frequency range: 30 MHz to 6 GHz. Good system EMI design practice required to achieve Class B margins. System margins depend on customer host board and chassis design.
Immunity	EN 55024:1998+A1+A2 IEC 61000-4-3	Compliant with standards. 1kHz sine-wave, 80% AM, from 80 MHz to 1 GHz. No effection transmitter/receiver performance is detectable between these limits.
Laser Eye Safety	FDA 21CFR 1040.10 and 1040.11 EN (IEC) 60825-1:2007 EN (IEC) 60825-2:2004+A1	CDRH compliant and Class I laser product. TüV Certificate No. 50135086
Component Recognition	UL and CUL EN60950-1:2006	UL file E317337 TüV Certificate No. 50135086 (CB scheme)
RoHS6	2002/95/EC 4.1&4.2 2005/747/EC 5&7&13	Compliant with standards *note

Note:

In light of item 5 in RoHS exemption list of RoHS Directive 2002/95/EC, Item 5: Lead in glass of cathode ray tubes, electronic components and fluorescent tubes.

In light of item 13 in RoHS exemption list of RoHS Directive 2005/747/EC, Item 13: Lead and cadmium in optical and filter glass. The three exemptions are being concerned for TONGSION's transceivers, because TONGSION's transceivers use glass, which may contain Pb, for components such as lenses, isolators, and other electronic components.



Ordering information

Part Number	Product Description		
TS-XFP-CWDM-80	1470nm~1610nm, 10Gbps, LC, 80km, 0°C~+70°C, With DDM		

Note: xx refers to CWDM Wavelength, from 1470nm to 1610nm, xx=47, 49...and 61.

Important Notice

Performance figures, data and any illustrative material provided in this data sheet are typical and must be specifically confirmed in writing by TONGSION before they become applicable to any particular order or contract. In accordance with the TONGSION policy of continuous improvement specifications may change without notice.

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